

DATA SHEET

BFG541

NPN 9 GHz wideband transistor

Product specification

September 1995



NPN 9 GHz wideband transistor**BFG541****FEATURES**

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability.

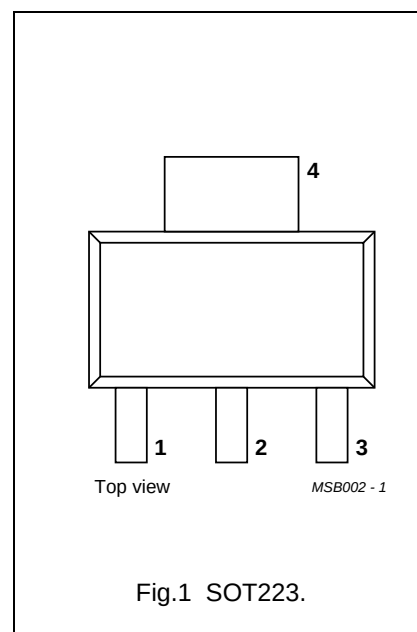
PINNING

PIN	DESCRIPTION
1	emitter
2	base
3	emitter
4	collector

DESCRIPTION

NPN silicon planar epitaxial transistor, intended for wideband applications in the GHz range, such as analog and digital cellular telephones, cordless telephones (CT1, CT2, DECT, etc.), radar detectors, satellite TV tuners (SATV), MATV/CATV amplifiers and repeater amplifiers in fibre-optic systems.

The transistors are mounted in a plastic SOT223 envelope.



NPN 9 GHz wideband transistor

BFG541

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	–	20	V
V_{CES}	collector-emitter voltage	$R_{BE} = 0$	–	–	15	V
I_C	DC collector current		–	–	120	mA
P_{tot}	total power dissipation	up to $T_s = 140\text{ °C}$; note 1	–	–	650	mW
h_{FE}	DC current gain	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $T_j = 25\text{ °C}$	60	120	250	
C_{re}	feedback capacitance	$I_C = 0$; $V_{CB} = 8\text{ V}$; $f = 1\text{ MHz}$	–	0.7	–	pF
f_T	transition frequency	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25\text{ °C}$	–	9	–	GHz
G_{UM}	maximum unilateral power gain	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ °C}$	–	15	–	dB
		$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$; $T_{amb} = 25\text{ °C}$	–	9	–	dB
$ S_{21} ^2$	insertion power gain	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ °C}$	13	14	–	dB
F	noise figure	$\Gamma_s = \Gamma_{opt}$; $I_C = 10\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ °C}$	–	1.3	1.8	dB
P_{L1}	output power at 1 dB gain compression	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 50\text{ }\Omega$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ °C}$	–	21	–	dBm
ITO	third order intercept point	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 50\text{ }\Omega$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ °C}$	–	34	–	dBm

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	20	V
V_{CES}	collector-emitter voltage	$R_{BE} = 0$	–	15	V
V_{EBO}	emitter-base voltage	open collector	–	2.5	V
I_C	DC collector current		–	120	mA
P_{tot}	total power dissipation	up to $T_s = 140\text{ °C}$; note 1	–	650	mW
T_{stg}	storage temperature		–65	150	°C
T_j	junction temperature		–	175	°C

THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE
$R_{th\ j-s}$	thermal resistance from junction to soldering point	up to $T_s = 140\text{ °C}$; note 1	55 K/W

Note

1. T_s is the temperature at the soldering point of the collector tab.

NPN 9 GHz wideband transistor

BFG541

CHARACTERISTICS

$T_j = 25\text{ }^{\circ}\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0$; $V_{CB} = 8\text{ V}$	—	—	50	nA
h_{FE}	DC current gain	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$	60	120	250	
C_e	emitter capacitance	$I_C = I_E = 0$; $V_{EB} = 0.5\text{ V}$; $f = 1\text{ MHz}$	—	2	—	pF
C_c	collector capacitance	$I_E = I_C = 0$; $V_{CB} = 8\text{ V}$; $f = 1\text{ MHz}$	—	1	—	pF
C_{re}	feedback capacitance	$I_C = 0$; $V_{CB} = 8\text{ V}$; $f = 1\text{ MHz}$	—	0.7	—	pF
f_T	transition frequency	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$	—	9	—	GHz
G_{UM}	maximum unilateral power gain (note 1)	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$	—	15	—	dB
		$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$	—	9	—	dB
$ S_{21} ^2$	insertion power gain	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$	13	14	—	dB
F	noise figure	$\Gamma_S = \Gamma_{opt}$; $I_C = 10\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$	—	1.3	1.8	dB
		$\Gamma_S = \Gamma_{opt}$; $I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$	—	1.9	2.4	dB
		$\Gamma_S = \Gamma_{opt}$; $I_C = 10\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$	—	2.1	—	dB
P_{L1}	output power at 1 dB gain compression	$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 50\text{ }\Omega$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$	—	21	—	dBm
ITO	third order intercept point	note 2	—	34	—	dBm
V_o	output voltage	note 3	—	500	—	mV
d_2	second order intermodulation distortion	note 4	—	−50	—	dB

Notes

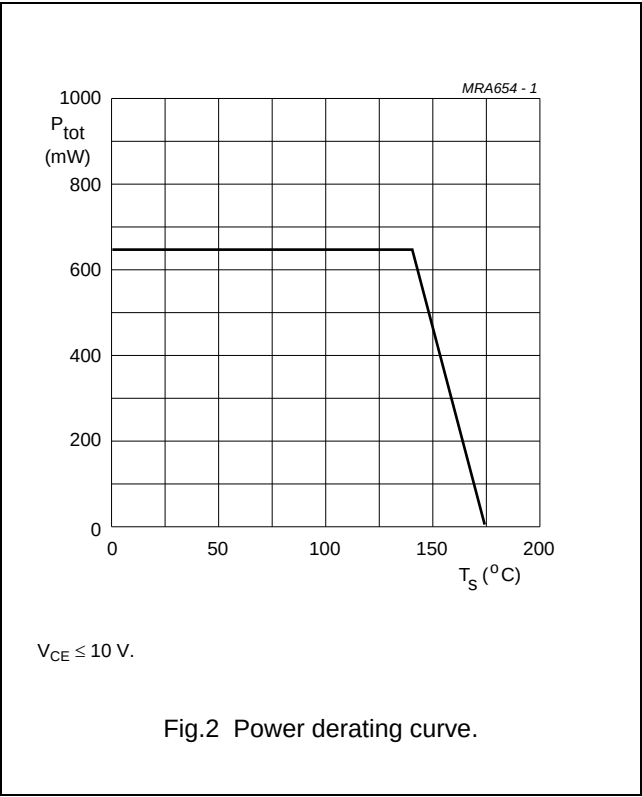
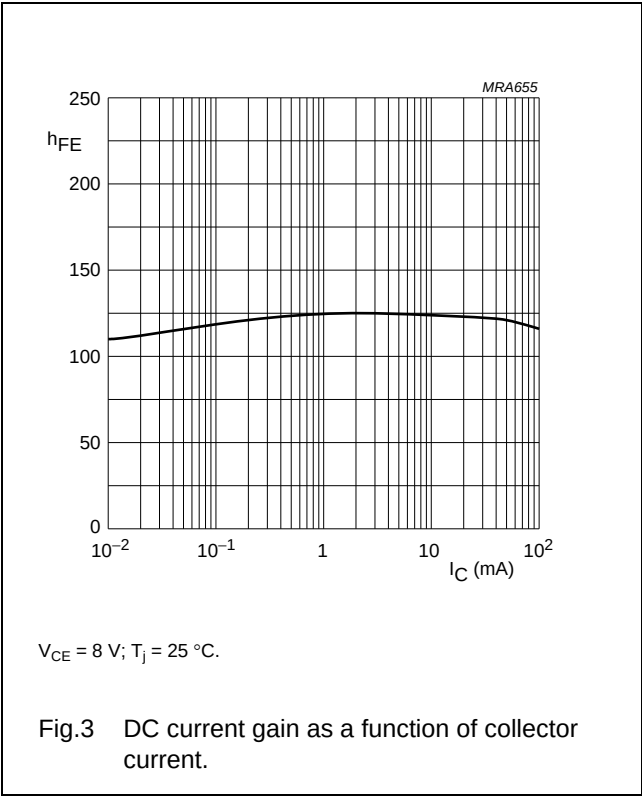
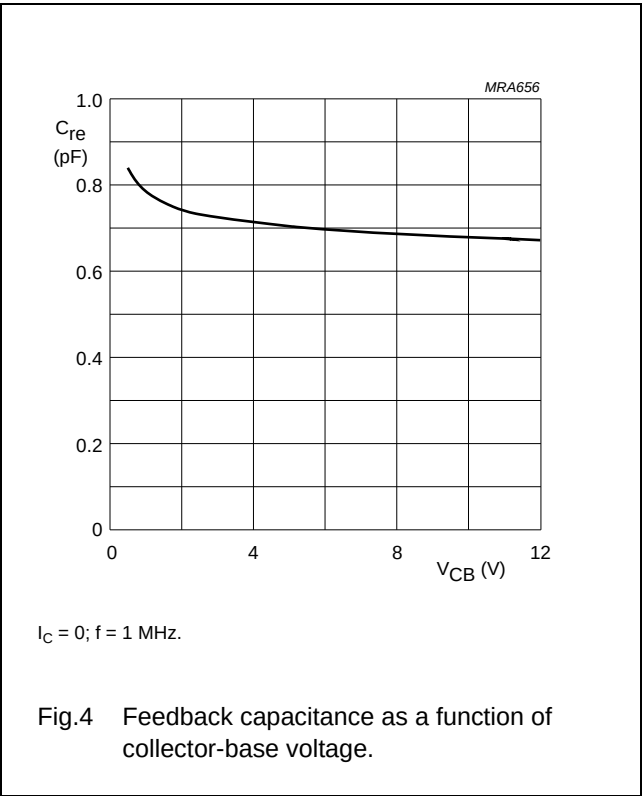
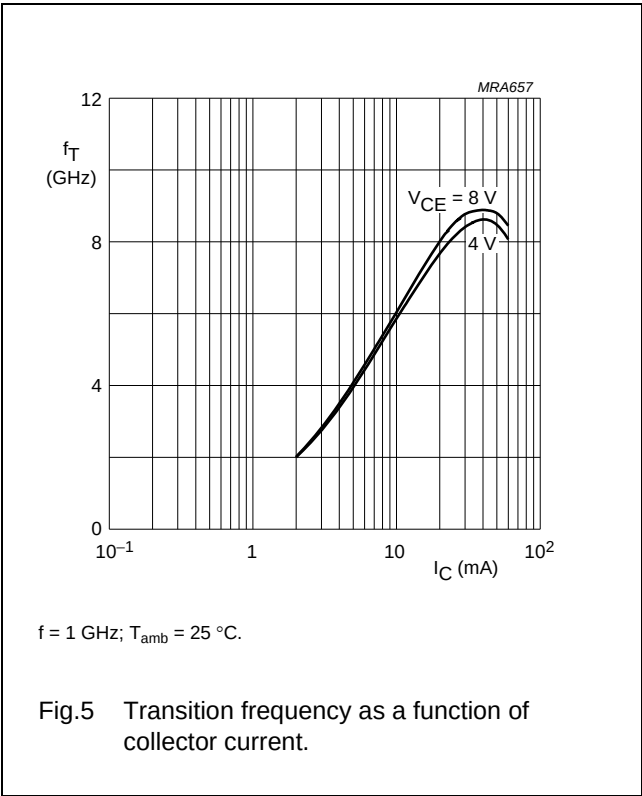
1. G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and

$$G_{UM} = 10 \log \frac{|S_{21}|^2}{(1 - |S_{11}|^2)(1 - |S_{22}|^2)} \text{ dB.}$$

2. $I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 50\text{ }\Omega$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$;
 $f_p = 900\text{ MHz}$; $f_q = 902\text{ MHz}$;
 measured at $f_{(2p-q)} = 898\text{ MHz}$ and at $f_{(2p-q)} = 904\text{ MHz}$.
3. $d_{im} = -60\text{ dB}$ (DIN 45004B); $I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $Z_L = Z_S = 75\text{ }\Omega$; $T_{amb} = 25\text{ }^{\circ}\text{C}$;
 $V_p = V_o$; $V_q = V_o - 6\text{ dB}$; $V_r = V_o - 6\text{ dB}$;
 $f_p = 795.25\text{ MHz}$; $f_q = 803.25\text{ MHz}$; $f_r = 805.25\text{ MHz}$;
 measured at $f_{(p+q-r)} = 793.25\text{ MHz}$
4. $I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $V_o = 325\text{ mV}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$;
 $f_p = 250\text{ MHz}$; $f_q = 560\text{ MHz}$;
 measured at $f_{(p+q)} = 810\text{ MHz}$

NPN 9 GHz wideband transistor

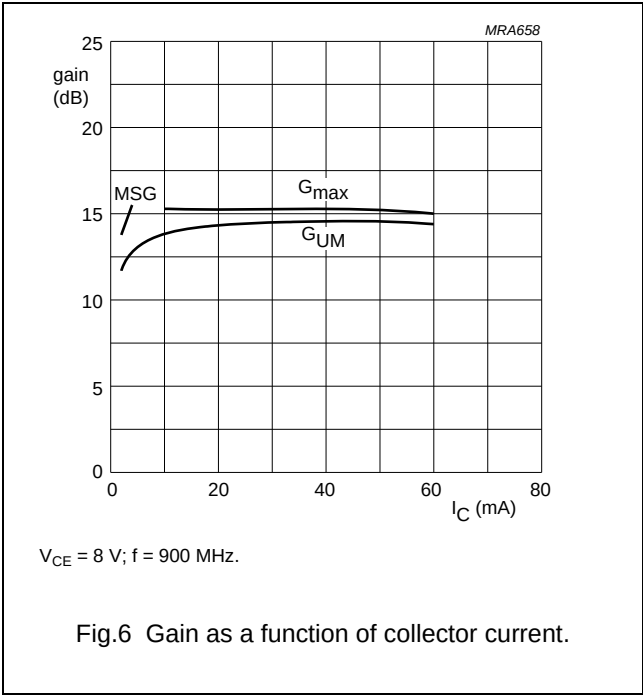
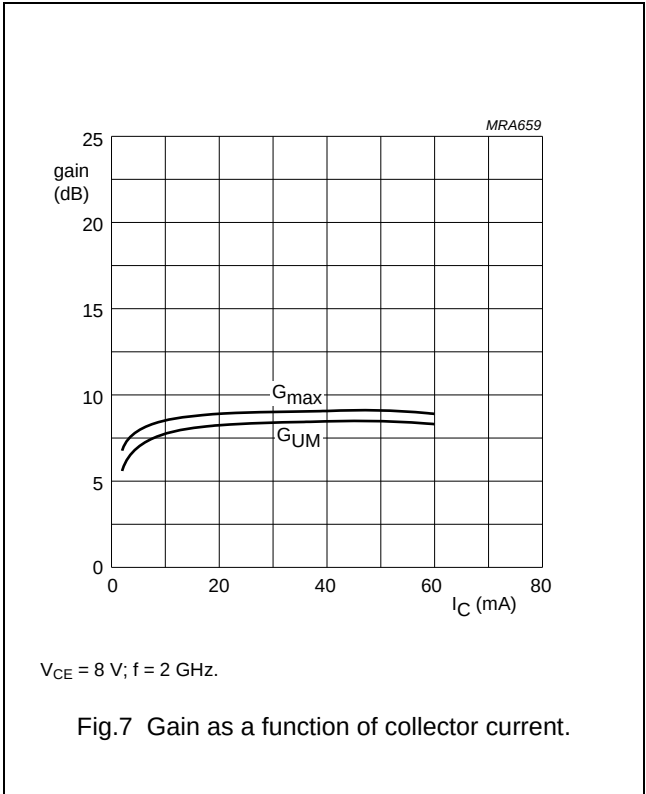
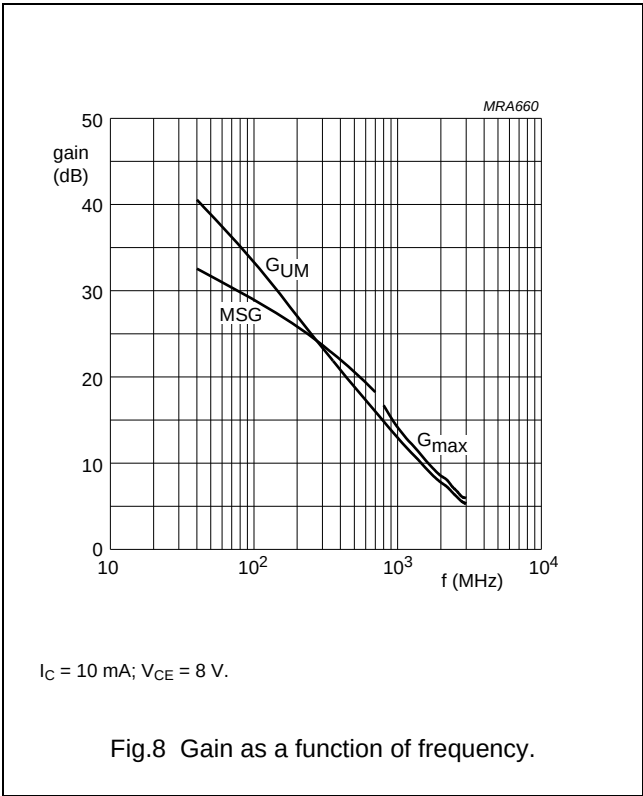
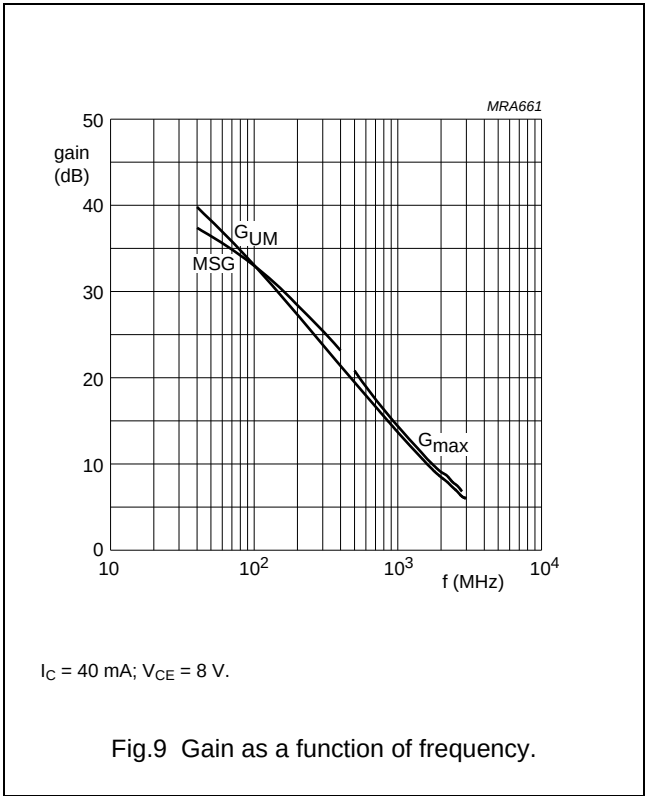
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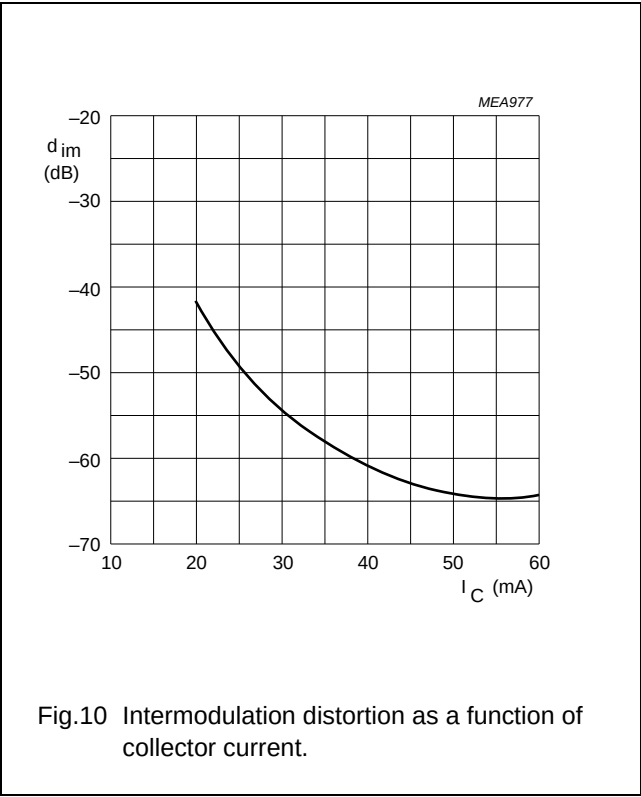
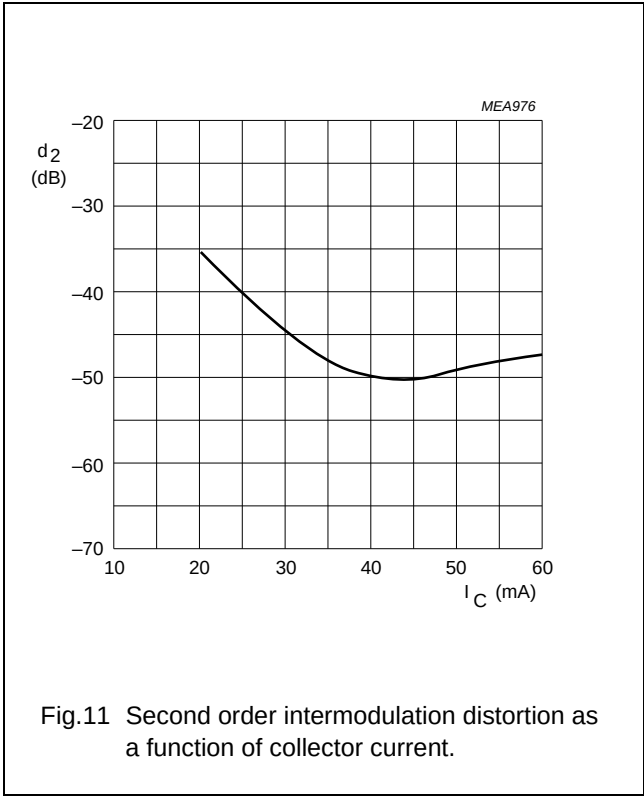
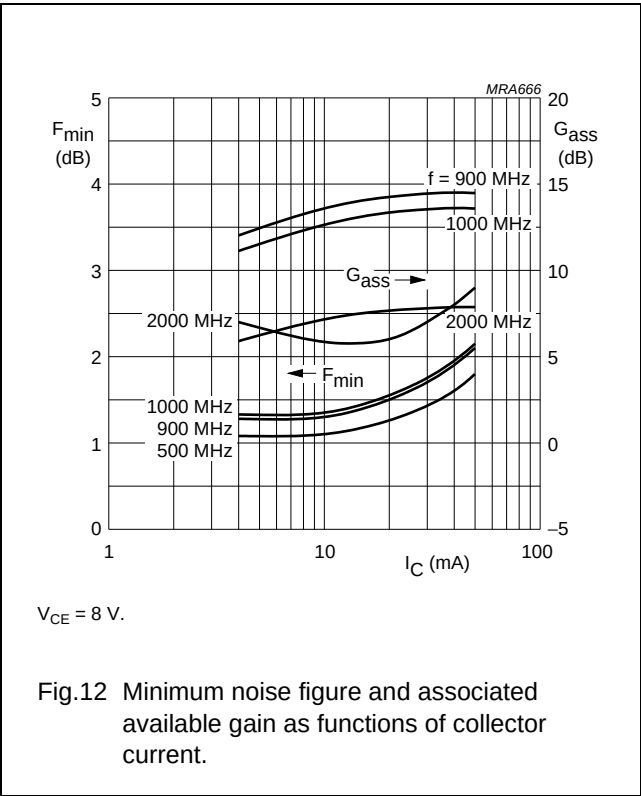
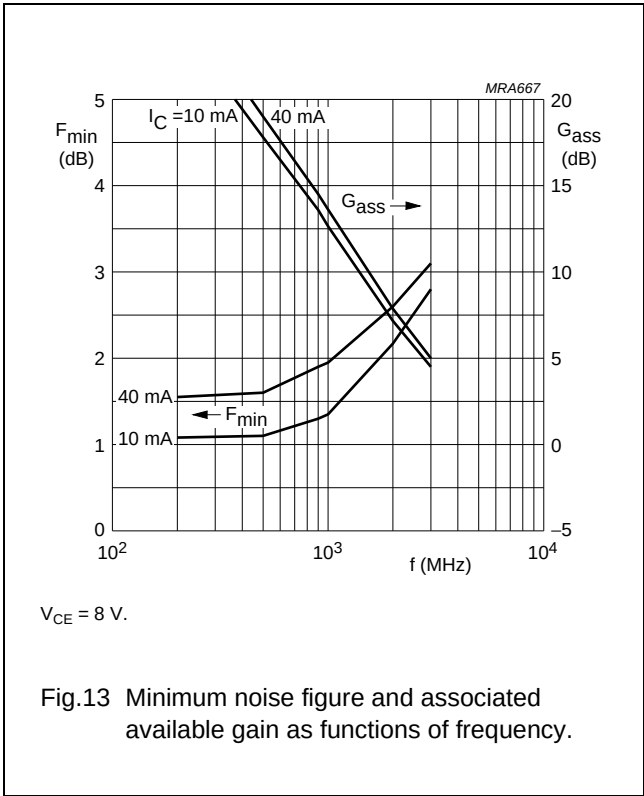
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In Figs 6 to 9, G_{UM} = maximum power gain; MSG = maximum stable gain; G_{max} = maximum available gain.



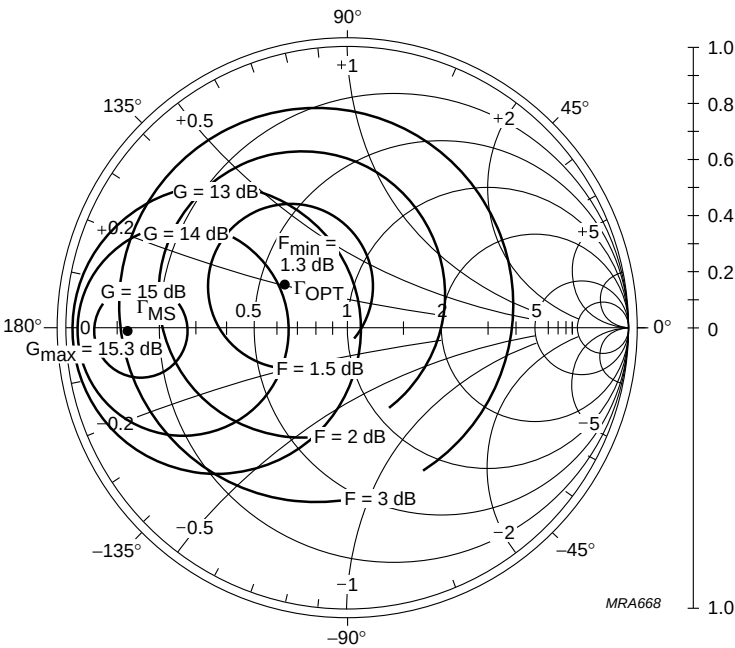
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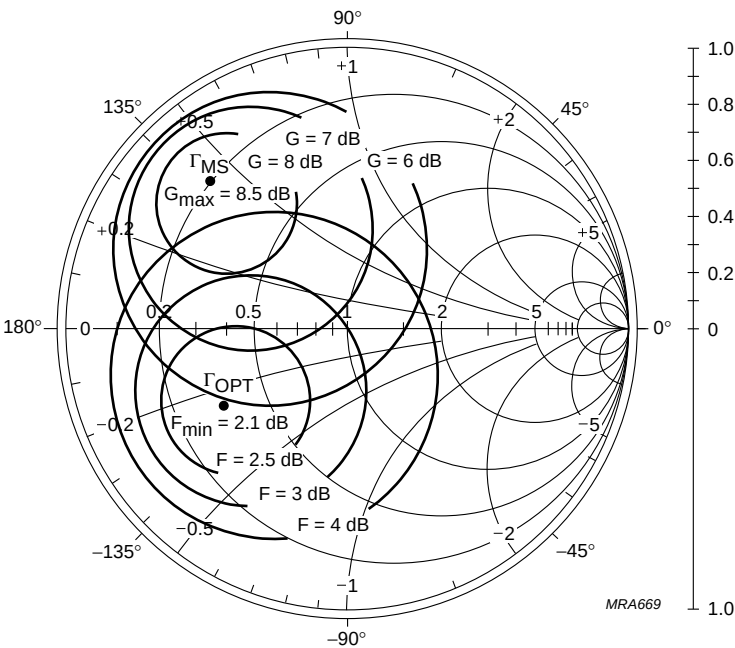
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$I_C = 10 \text{ mA}$; $V_{CE} = 8 \text{ V}$;
 $Z_0 = 50 \Omega$; $f = 900 \text{ MHz}$.

Fig.14 Noise circle figure.

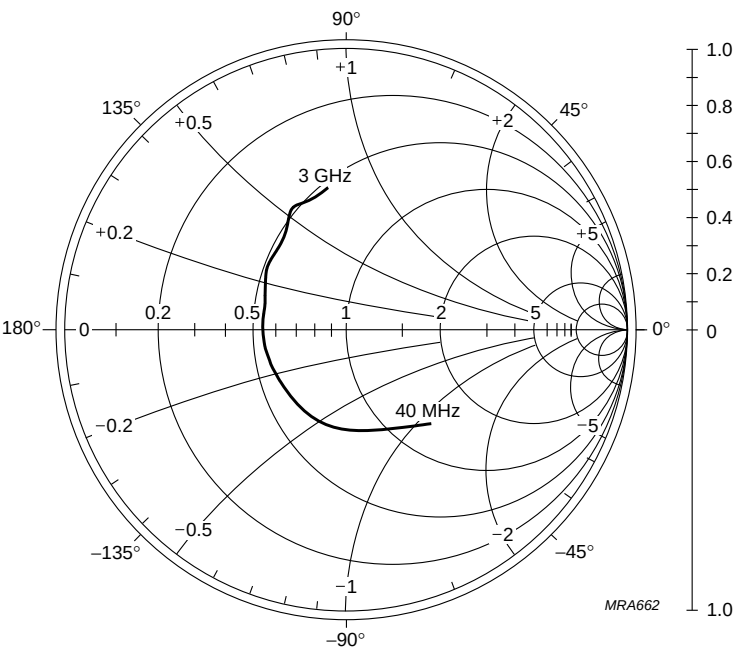


$I_C = 10 \text{ mA}$; $V_{CE} = 8 \text{ V}$;
 $Z_0 = 50 \Omega$; $f = 2 \text{ GHz}$.

Fig.15 Noise circle figure.

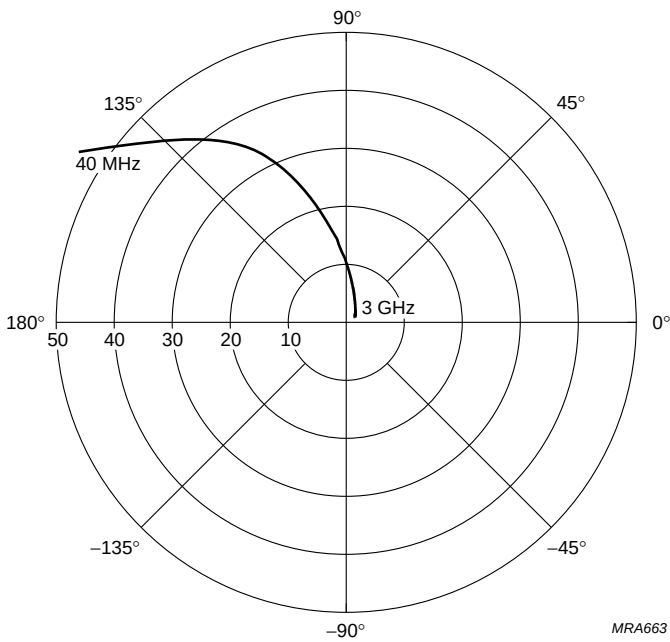
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$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$.
 $Z_0 = 50\ \Omega$.

Fig.16 Common emitter input reflection coefficient (S_{11}).

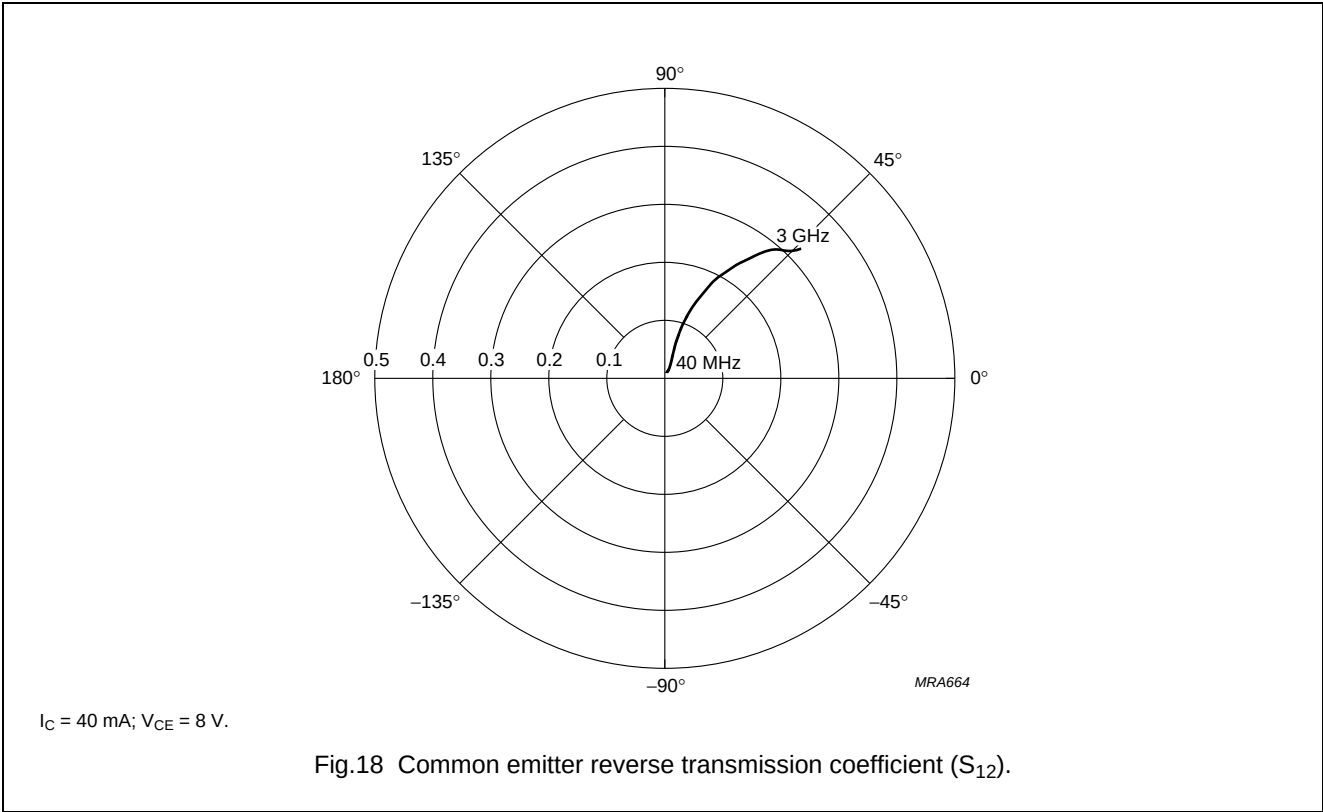
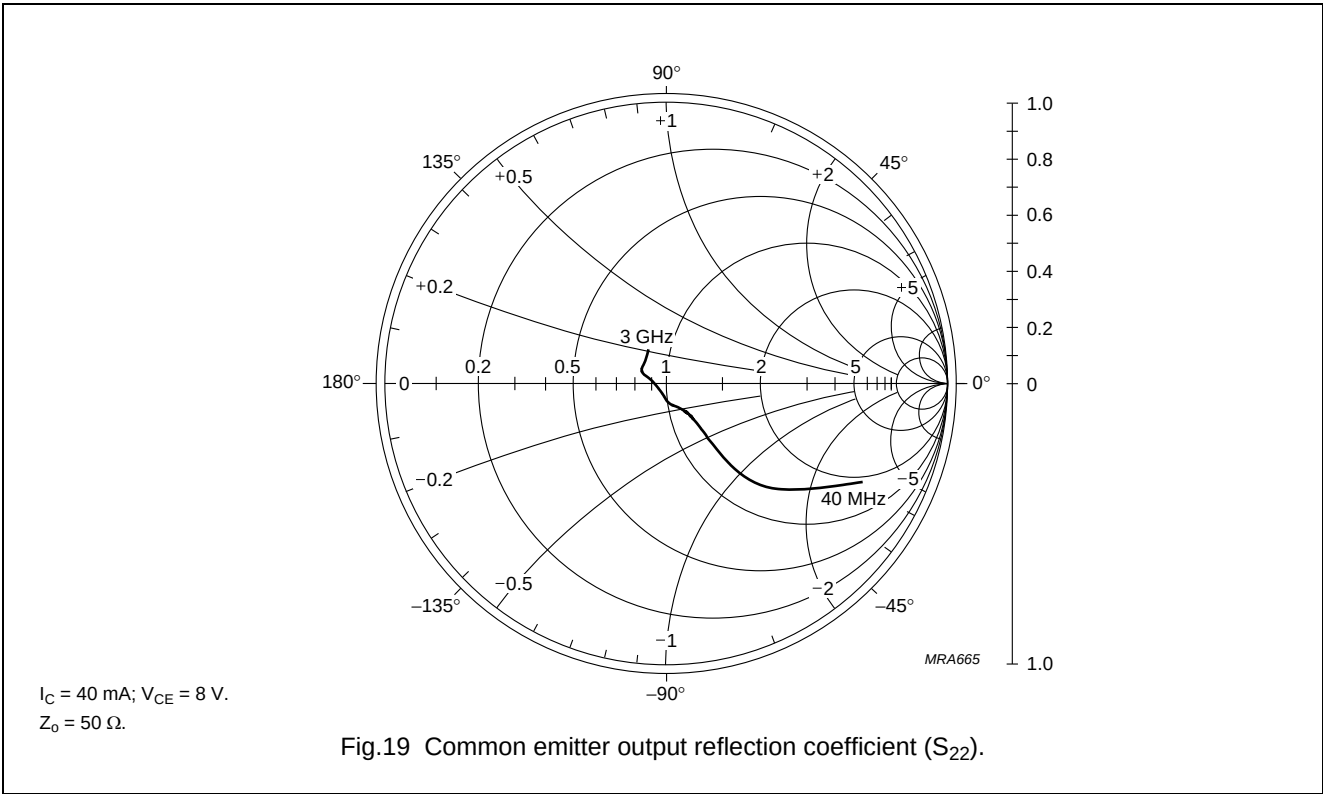


$I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$.

Fig.17 Common emitter forward transmission coefficient (S_{21}).

NPN 9 GHz wideband transistor

BFG541



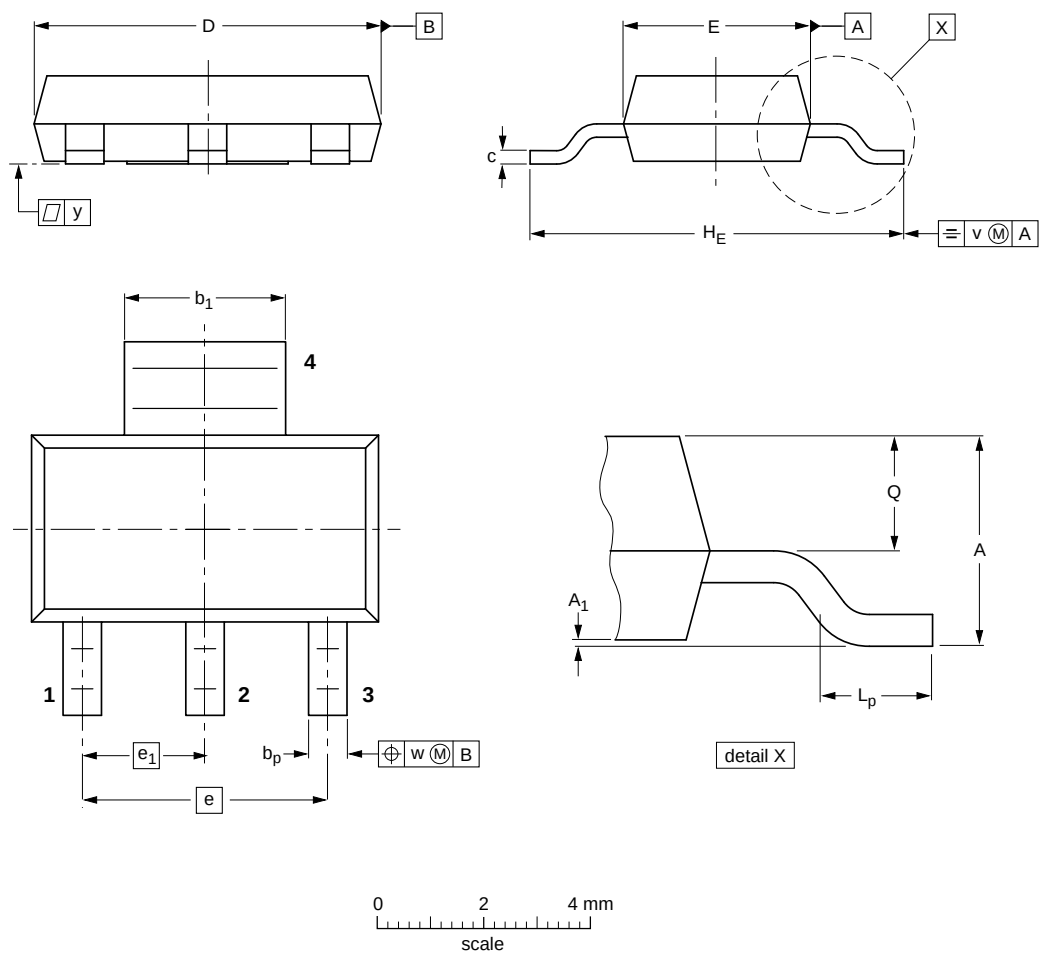
NPN 9 GHz wideband transistor

BFG541

PACKAGE OUTLINE

Plastic surface-mounted package with increased heatsink; 4 leads

SOT223



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁	b _p	b ₁	c	D	E	e	e ₁	H _E	L _p	Q	v	w	y
mm	1.8 1.5	0.10 0.01	0.80 0.60	3.1 2.9	0.32 0.22	6.7 6.3	3.7 3.3	4.6	2.3	7.3 6.7	1.1 0.7	0.95 0.85	0.2	0.1	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT223			SC-73			04-11-10 06-03-16

NPN 9 GHz wideband transistor

BFG541

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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BFG541

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